Product data sheet

1. General description

The 74LVC02A provides four 2-input NOR gates.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

3. Ordering information

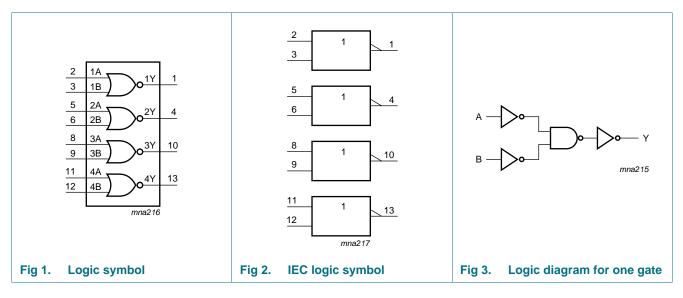
Table 1.Ordering information

Type number	Package						
	Temperature range Name		Description	Version			
74LVC02AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LVC02ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1			
74LVC02APW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC02ABQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			



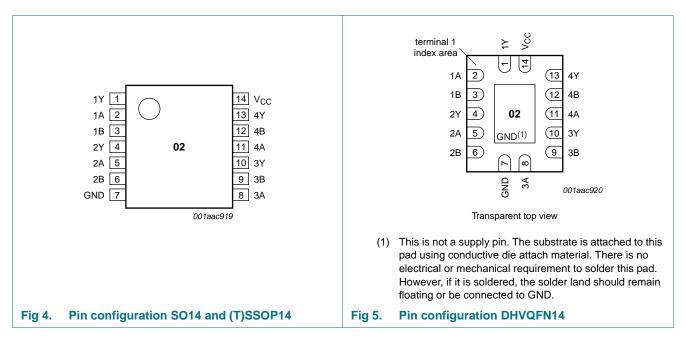
74LVC02A Quad 2-input NOR gate

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1Y to 4Y	1, 4, 10, 13	data output
1A to 4A	2, 5, 8, 11	data input
1B to 4B	3, 6, 9,12	data input
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3.	Function table ^[1]
----------	-------------------------------

Input nA	Input nB	Output nY
L	L	Н
Х	Н	L
Н	Х	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	output in HIGH or LOW-state	[2] -0.5	V _{CC} + 0.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	<u>[3]</u>	500	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO14 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

Quad 2-input NOR gate

8. Recommended operating conditions

Table 5.	Recommended operating cond	itions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

		<u> </u>			,			
Symbol	Parameter	er Conditions	–40 °C to +85 °C			–40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65\ \times\ V_{CC}$	-	-	$0.65 \times V_{\text{CC}}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA

Quad 2-input NOR gate

Symbol Parar	Parameter	Conditions	-4	0 °C to +8	85 °C	-40 °C t	–40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μA
∆I _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V$ to 3.6 V; $V_I = V_{CC} - 0.6 V$; $I_O = 0 A$	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_{I} = GND$ to V_{CC}	-	4.0	-	-	-	pF

Table 6. Static characteristics ... continued

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. **Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions	Conditions		–40 °C to +85 °C		–40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t _{pd}	propagation delay	nA, nB to nY; see Figure 6	[2]		•		1	1	
		V _{CC} = 1.2 V		-	14	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		0.5	4.0	8.6	0.5	10.1	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.4	4.9	1.0	5.7	ns
		$V_{CC} = 2.7 V$		1.0	2.5	5.1	1.0	6.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.2	4.4	1.0	5.5	ns
t _{sk(o)}	output skew time	V_{CC} = 3.0 V to 3.6 V	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per gate; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	2.5	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	5.7	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V		-	8.5	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

Quad 2-input NOR gate

11. AC waveforms

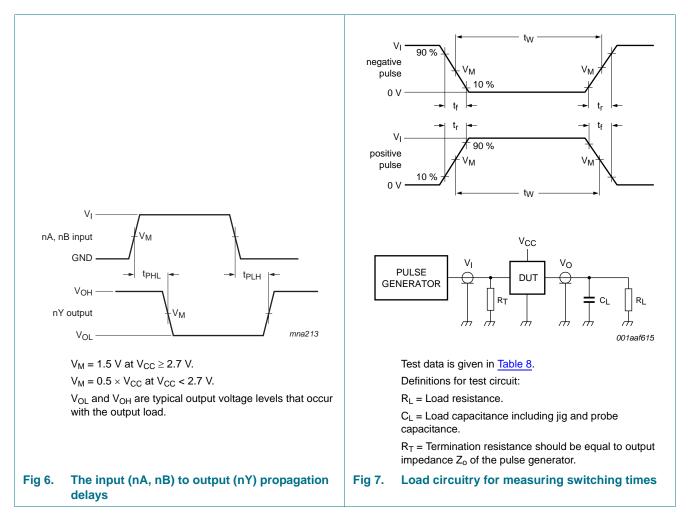


Table 8. Test data

Supply voltage	Input		Load		
	VI	t _r , t _f	CL	RL	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	

Quad 2-input NOR gate

12. Package outline

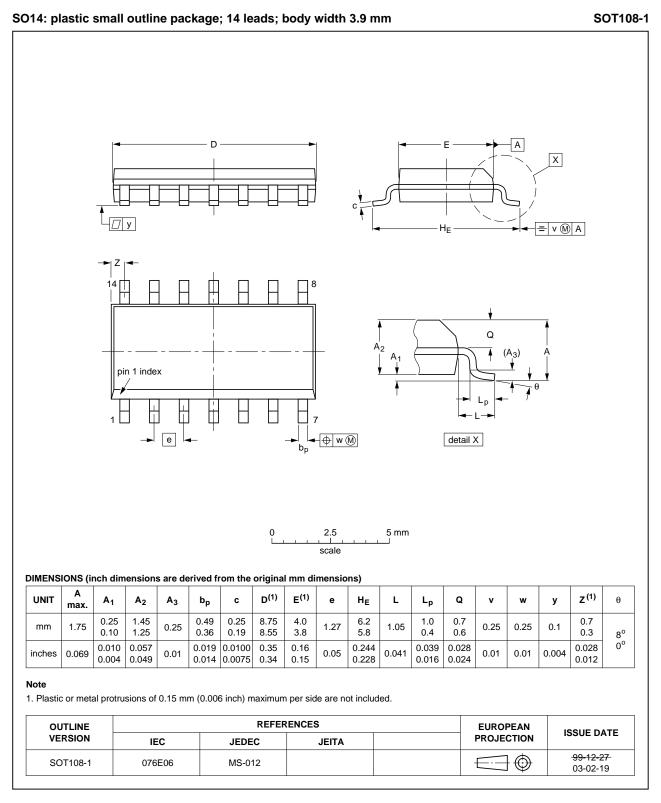


Fig 8. Package outline SOT108-1 (SO14)

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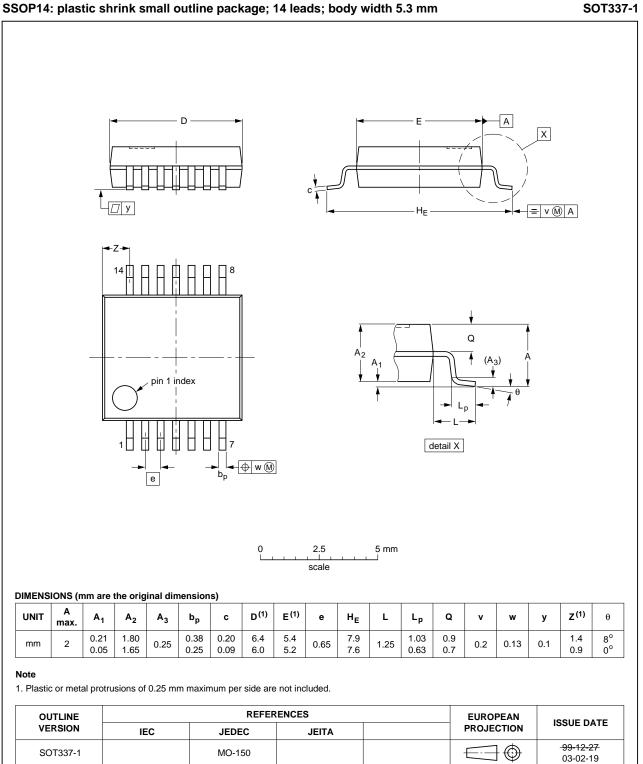


Fig 9. Package outline SOT337-1 (SSOP14)

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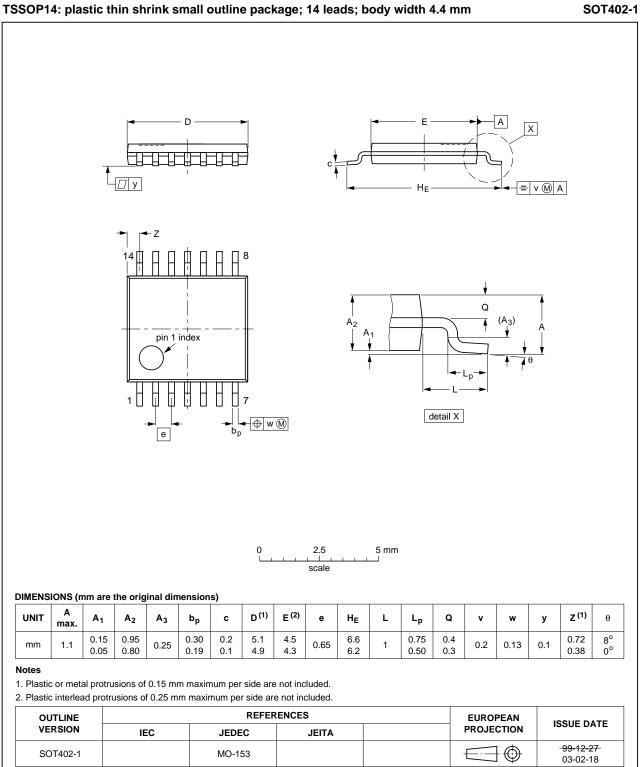
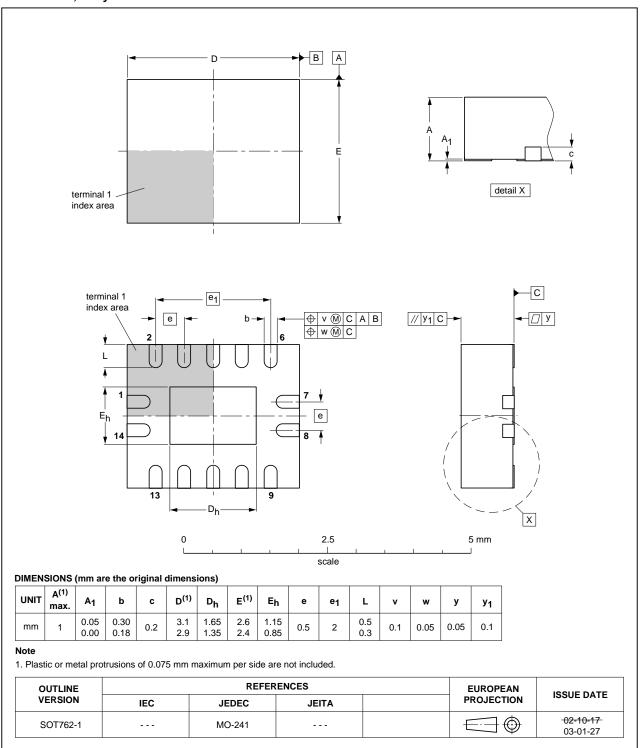


Fig 10. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 11. Package outline SOT762-1 (DHVQFN14)

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13. Abbreviations

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC02A v.8	20111116	Product data sheet	-	74LVC02A v.7
Modifications:	 Legal pages update 	ted.		
	• <u>Table 6</u> , bodyrow	∆I _{CC} : condition V _{CC} chang	ged.	
74LVC02A v.7	20111019	Product data sheet	-	74LVC02A v.6
74LVC02A v.6	20110809	Product data sheet	-	74LVC02A v.5
74LVC02A v.5	20040312	Product specification	-	74LVC02A v.4
74LVC02A v.4	20030501	Product specification	-	74LVC02A v.3
74LVC02A v.3	20020305	Product specification	-	74LVC02A v.2
74LVC02A v.2	19980428	Product specification	-	74LVC02A v.1
74LVC02A v.1	19970811	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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74LVC02A

Rev. 8 — 16 November 2011

Quad 2-input NOR gate

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